

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Hiroshi Fukui

Confirmation No.: 7869

Serial No.: 10/533,849

Filed: October 24, 2005

Group Art Unit: 1796

Examiner: Loewe, Robert S.

For: HEAT CONDUCTIVE SILICONE COMPOSITION

AMENDMENT

Mailstop AMENDMENT
Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

Dear Sir:

In response to the Office Action dated May 7, 2008, please amend the claims as follows and consider the accompanying remarks. A complete listing of all claims pending in the application is included in accordance with 37 CFR § 1.121. This response is timely filed; thus, it is believed that no fees are presently due.